# RENESAS

## HVL358CM

Variable Capacitance Diode for VCO

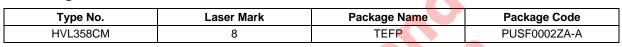
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REJ03G0038-0400 Rev.4.00 Mar 10, 2006

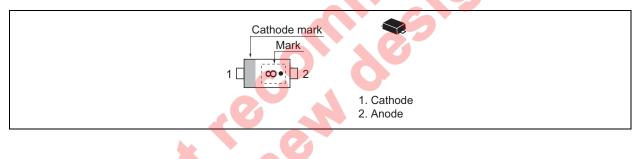
### Features

- High capacitance ratio. (n = 2.20 min)
- Low series resistance. (rs =  $0.40 \Omega \text{ max}$ )
- Good C-V linearity
- Thin Extremely small Flat Lead Package (TEFP) is suitable for surface mount design.

### **Ordering Information**



### **Pin Arrangement**





### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit
Reverse voltage	V <sub>R</sub>	15	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	–55 to +125	C°

### **Electrical Characteristics**

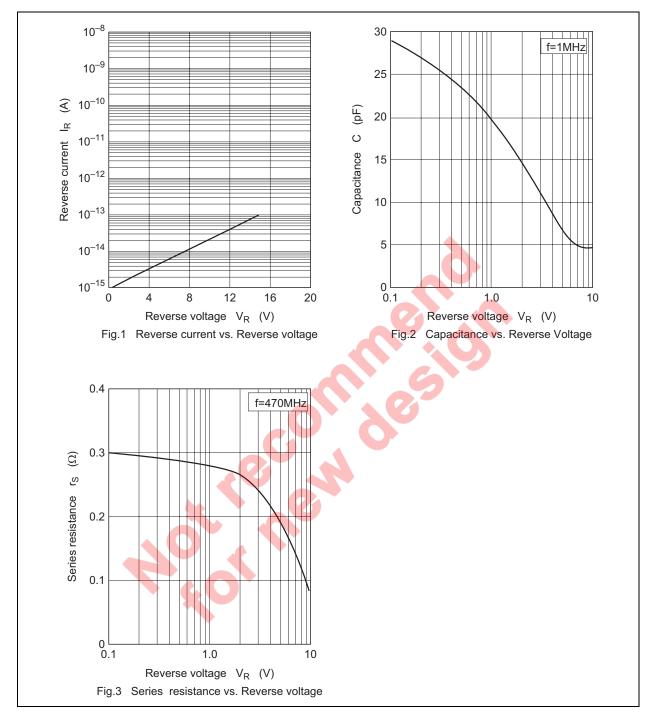
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R1</sub>	_		10	nA	V <sub>R</sub> = 15 V
	I <sub>R2</sub>	_	_	100		V <sub>R</sub> = 15 V, Ta = 60°C
Capacitance	C <sub>1</sub>	19.50		20.90	pF	$V_R = 1 V$ , f = 1 MHz
	C <sub>4</sub>	8.30		8.95		$V_R = 4 V, f = 1 MHz$
Capacitance ratio	n	2.20		2.43	_	C <sub>1</sub> / C <sub>4</sub>
Series resistance	r <sub>s</sub>			0.40	Ω	V <sub>R</sub> = 1 V, f = 470 MHz

Note: For TEFP package, the material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

Rev.4.00 Mar 10, 2006 page 2 of 4

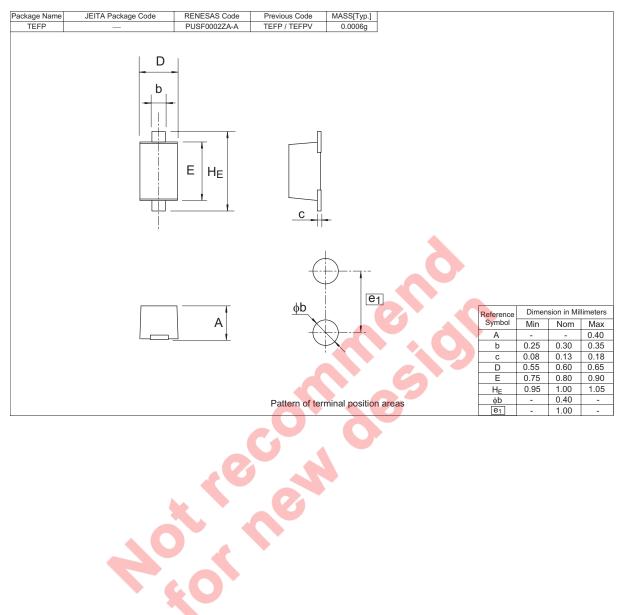


## **Main Characteristic**





### **Package Dimensions**





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